

L Number	Hits	Search Text	DB	Time stamp
1	4418	(bonding or wirebonding) near3 (pad or electrode) near15 (non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 12:00
2	4419	(bonding or wirebonding) near3 (pad or electrode) near15 (non-oxidiz\$5 or nonoxidiz\$5 or non adj oxidiz\$5 or gold or Au or platinum or Pt or palladium or pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 12:00
3	817	(bonding or wirebonding) near2 (pad or electrode) near10 (barrier or adhesion or Cr or chromium or copper or cu or vanadium or v or crcu or nickel or ni) near10 (non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 12:12
4	294	(wire near bonding or wirebonding) near5 (pad or electrode) near10 (barrier or adhesion or Cr or chromium or copper or cu or vanadium or v or crcu or nickel or ni) near10 (non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:10
5	20	("5445311" "5567981" "5792594" "5910644" "6064112" "6127736" "6218281" "6232147" "6303524" "6335104" "6372624" "6380555" "6388333" "6396148" "6403457" "6451624" "6455408" "6501165" "6620633" "6620731").PN.	USPAT	2004/09/28 12:48
6	89	(bonding or wirebonding) near5 (pad or electrode) near10 (barrier or adhesion or Cr or chromium or copper or cu or vanadium or v or crcu or nickel or ni) near10 (non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) same (redistribution or redistributing or redistribute or redistributed or trace or finger or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:31
7	35	(non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) near8 (seal or sealing or enveloping or sealed or enveloped or surrounding or surrounded or surround) near10 (redistribution or redistributing or redistribute or redistributed or trace or finger or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:45
8	5	(non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) near8 (covering or cover or covered) near2 (completely or wholly or edges or entirely or complete or entire) near10 (redistribution or redistributing or redistribute or redistributed or trace or finger or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:42
9	5	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au or platinum or Pt or palladium or pd) near8 (covering or cover or covered) near2 (completely or wholly or edges or entirely or complete or entire) near10 (redistribution or redistributing or redistribute or redistributed or trace or finger or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:42
10	14	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au or platinum or Pt or palladium or pd) near8 (covering or cover or covered) near2 (completely or wholly or edges or entirely or complete or entire) near10 (redistribution or redistributing or redistribute or redistributed or trace or finger or interconnect or wiring)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:42

11	36	(non-oxidizing or nonoxidizing or gold or Au or platinum or Pt or palladium or pd) near8 (seal or sealing or enveloping or sealed or enveloped or surrounding or surrounded or surround) near10 (wirebonding or wirebond or wirebonded or wire near bond or wire near bonding or wire near bonded) near3 (pad or electrode or surface or area or region)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:46
12	36	(non-oxidiz\$5 or nonoxidiz\$5 or gold or Au or platinum or Pt or palladium or pd) near8 (seal or sealing or enveloping or sealed or enveloped or surrounding or surrounded or surround) near10 (wirebonding or wirebond or wirebonded or wire near bond or wire near bonding or wire near bonded) near3 (pad or electrode or surface or area or region)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/28 13:46